Application No.: 10/665,523

Art Unit:

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## **AMENDMENTS TO THE CLAIMS**

This listing of claims will replace all prior versions, and listings, of claims in the application.

## **Listing of Claims:**

Claims 1-5. (Canceled without prejudice or disclaimer).

6. (Previously Presented) A circuit board comprising:

an insulator plate;

a conductor layer bonded to a surface of the insulator plate;

a dielectric layer provided in a gap portion between the insulator plate and the conductor layer wherein:

the following relationship exists among the dielectric constant of the dielectric layer  $\mathfrak{E}_g$ , the dielectric constant of the insulator plate  $\mathfrak{E}_b$ , the thickness of the gap portion  $L_g$ , and the thickness of the insulator plate  $L_b$ ,

 $\varepsilon_g \ge \varepsilon_b \times (L_g/L_b)$ .